

<b>Company</b>		<b>DUNS#</b>	<b>URL For Additional Information</b>
National Semiconductor		04-147-2986	<a href="http://www.national.com/analog/quality/green">http://www.national.com/analog/quality/green</a>

<b>Contact</b>	<b>Title</b>	<b>Phone</b>	<b>Email</b>
Lorena Dudman	Product Stewardship Eng. Mgr	1-408-721-8180	Green.Project@nsc.com

<b>Part Number</b>	<b>MSL Rating</b>	<b>Peak Body Temp C</b>	<b>MaxTime(Sec)</b>	<b>Cycles</b>	<b>Unit Type</b>
LM10BH NOPB	1	NA	NA	NA	Each

<b>Document Date</b>	European RoHS Compliant. China RoHS Compliant.	<b>Weight (mg)</b>	Does NOT Contain Halogens
01-17-2012		984.76	

### Material Composition Declaration for Electronic Products

Item	Weight (mg)	Component	CAS#	Weight (mg)	Item-ppm	Part-ppm
Ext. LeadFinish	7.860	Sn	7440-31-5	7.585	965,000	7,702
		Ag	7440-22-4	0.236	30,000	240
		Cu	7440-50-8	0.039	5,000	40
Stand-off	69.700	Al2O3	1344-28-1	69.700	1,000,000	70,779
Lid	309.500	Ni	7440-02-0	309.500	1,000,000	314,291
Chip	3.751	Si	7440-21-3	3.728	994,000	3,786
		Al	7429-90-5	0.023	6,000	23
Eyelet	279.400	Fe	7439-89-6	150.876	540,000	153,211
		Ni	7440-02-0	81.026	290,000	82,280
		Co	7440-48-4	47.498	170,000	48,233
Leads	173.000	Fe	7439-89-6	93.420	540,000	94,866
		Ni	7440-02-0	50.170	290,000	50,947
		Co	7440-48-4	29.410	170,000	29,865
Glass	130.800	SiO2	60676-86-0	105.425	806,000	107,057
		B2O3	1303-86-2	17.004	130,000	17,267
		Na2O	12401-86-4	5.232	40,000	5,313
		Al2O3	1344-28-1	3.139	24,000	3,188
Plating	10.300	Ni	7440-02-0	10.300	1,000,000	10,459
Die Attach	0.411	Ag	7440-22-4	0.308	750,000	313
		Epoxy Resin	25928-94-3	0.103	250,000	105
Wires	0.035	Al	7429-90-5	0.035	1,000,000	36

**Note:** The device content disclosed herewith is approximate and is based on engineering estimates only. It has not been verified through analytical testing.

Additionally, the following should be noted:

- One or more dopant materials may be present in the silicon die at sub-ppm levels to provide semiconductor properties.
- Epoxy resin components listed are generic and may or may not be the specific compound used, which is considered proprietary.

### RoHS Material Composition Declaration

<b>RoHS Directive 2002/95/EC</b>	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium
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Subject to the limitations below, National Semiconductor Corporation ("National") certifies the following information as of the document date.

- National products designated "ROHS Compliant" comply with the European Unions Directive on the Restriction of the Use of Hazardous Substances 2002/95/EC ("RoHS"). Certain National products contain lead in RoHS exempt applications 7(a) or 7(c)-I.
- National products do not contain and are not manufactured with ozone depleting compounds.
- National products do not contain substances identified by the European Chemical Agency ("ECHA") as substances of very high concern ("SVHC") per REACH Regulation (EC) No 1907/2006. National also complies with use restrictions as stipulated in Annex XVII of REACH.
- National products are manufactured in conformance with National specifications (SC)CSP-9-111C1 Supplier Environmental Requirements for Materials and Products and (SC)CSP-9-111S2 Banned and Reportable Substances.
- National's list of banned and reportable substances and management system is based on the current version of the Joint Industrial Guide, JIG-101.

National has taken commercially reasonable steps to provide representative and accurate information but may not have independently verified information provided or conducted chemical analysis of incoming materials. Equivalent compliant materials may have been substituted for those stated herein. Material concentrations are the maximum expected concentration of the substance in the device and may not represent the actual concentration. National and its suppliers consider certain limited information to be confidential and thus CAS numbers and other limited information may not be available for release. Nationals Standard Terms and Conditions of Sale apply to any issue arising out of or in connection with the information provided herein unless otherwise provided by a written contract signed by both parties.

NATIONAL ACCEPTS NO DUTY TO NOTIFY USERS OF THIS DECLARATION OF UPDATES OR CHANGES TO THIS DECLARATION.

*John L. Conn*  
John L. Conn  
Vice President Quality

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**Vice President Quality**

**Banned Substance Monitoring**

Part Number		Document Date
LM10BH	NOPB	01-17-2012

European RoHS Compliant.

China RoHS Compliant.

Item#	Material	Cd	CrVI	Pb	Hg	PBB	PBDE	Cl	Br	Ref#
1	CHIP	<1	<1	<1	<30	<10	<10	<75	<50	1000
2	EPOXY	<2	<2	<2	<2	<5	<5	<50	<50	32
3	HEADER	<2	<2	<2	<2	<5	<5	N/A	N/A	672
4	WIRE	<2	N/D	<2	<2	<5	<5	N/A	N/A	604

\* Cd: Cadmium, CrVI: Hexavalent Chromium, Pb: Lead, Hg: Mercury, NA: Not Applicable

\* Unless otherwise noted, units are in PPM (parts-per-million)

Ref#	3rd Party Analysis (available upon request, subject to a non-disclosure agreement)
1000	Analysis on 01/24/2011 by Balazs as per Report# 11-00322-00
32	Analysis on 04/29/2011 by SGS per Report# LPCI/04433(B)/11
672	Analysis on 04/29/2011 by SGS per Report# LPCI/04430(B)/11
604	Analysis on 04/29/2011 by SGS per Report# LPCI/04451(B)/11